Electronic Patent Application Fee Transmittal								
Application Number:	10519837							
Filing Date:	05-Jul-2005							
Title of Invention:	HIGH-RESISTANCE SILICON WAFER AND PROCESS FOR PRODUCING THE SAME							
First Named Inventor/Applicant Name:	Shinsuke Sadamitsu							
Filer:	Marvin Jay Spivak/Aida Melaku							
Attorney Docket Number:	264197US0PCT							
Filed as Large Entity								
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Basic Filing:								
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